



STYCAST 1090SI/Catalyst 24LV

June 2010

PRODUCT DESCRIPTION

STYCAST 1090SI/Catalyst 24LV provides the following product characteristics:

Technology	Epoxy
Appearance (Resin)	Black
Components	Two component - requires mixing
Mix Ratio, by weight - Resin : Hardener	100 : 23
Product Benefits	<ul style="list-style-type: none"> • Low density • Low dielectric constant • High compressive strength • Two component
Cure	Room temperature cure
Application	Encapsulant
Operating Temperature	-70 to 100 °C

STYCAST 1090SI/Catalyst 24LV encapsulant is recommended for applications where high compressive stress is applied to encapsulated circuitry - as in deep ocean work. This product will have a minimum effect on electronic circuit operation and shows negligible deformation and water absorption.

STYCAST 1090SI can be used with a variety of catalysts. For more information on mixed properties when used with other available catalysts, please contact your local technical service representative for assistance and recommendations.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Part A Properties 1090SI

Viscosity @ 25 °C, mPa·s (cP)	30,000 to 50,000
Specific Gravity	0.6 to 0.7
Shelf Life @ 18 to 25°C, months	12
Flash Point - See MSDS	

Mixed Properties

Mixed Viscosity, mPa·s (cP)	2,000 to 3,500
Pot Life @ 25 °C, minutes	30
Flash Point - See MSDS	

TYPICAL CURING PERFORMANCE

Cure Schedule

4 to 24 hours @ 25°C

Post Cure

4 hours @ 60 to 100°C may be required to achieve the best reliability results

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

Physical Properties:

Coefficient of Thermal Expansion ASTM D 3386, K ⁻¹	5.4×10 ⁻⁶
Thermal Conductivity, W/mk	0.17
Flexural strength, ASTM D790	N/mm ² 28 (psi) (4,060)
Tensile Strength, ISO 527-2	N/mm ² 15 (psi) (2,175)
Water Absorption, ISO 62, %:	
24 hours	≤0.4

Electrical Properties:

Volume Resistivity, IEC 60093, Ω·cm	≥1×10 ¹³
Dielectric Constant / Dissipation Factor, IEC 60250:	
60Hz	3.7 / 0.02
1 kHz	3.1 / 0.01
1 MHz	2.3 / 0.01
Dielectric Breakdown Strength, IEC 60243-1, kV/mm	≥14.7

GENERAL INFORMATION

For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).

DIRECTIONS FOR USE

1. Accurately weigh resin and hardener into a clean container in the recommended ratio.
2. Mix thoroughly in the can in which it is received.
3. Liquid diluents can be supplied to lower viscosity at some sacrifice in properties.
4. Pour mixture into cavity or mold.
5. Mold release 122 S will prevent adhesion. (Evacuation may be necessary to remove trapped air and is recommended for high quality embeddings. It is often convenient to remove the trapped air from the resin prior to pouring into mold, and then again evacuate briefly when the mold is filled).
6. Allow to stand at room temperature for about 4 hours. Removal from the mold prior to that time is possible if the casting is hard.
7. The filler will tend to float during storage. Premixing before use is required.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: 18 to 25 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Certain resins and hardeners are prone to crystallization. If crystallization does occur, warm the contents of the shipping container to 50 to 60°C until all crystals have dissolved. Be sure the shipping container is loosely covered during the warming stage to prevent any pressure build-up. Allow contents to cool to room temperature before continuing.

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

Conversions

$(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$
 $\text{kV/mm} \times 25.4 = \text{V/mil}$
 $\text{mm} / 25.4 = \text{inches}$
 $\text{N} \times 0.225 = \text{lb}$
 $\text{N/mm} \times 5.71 = \text{lb/in}$
 $\text{N/mm}^2 \times 145 = \text{psi}$
 $\text{MPa} \times 145 = \text{psi}$
 $\text{N}\cdot\text{m} \times 8.851 = \text{lb}\cdot\text{in}$
 $\text{N}\cdot\text{m} \times 0.738 = \text{lb}\cdot\text{ft}$
 $\text{N}\cdot\text{mm} \times 0.142 = \text{oz}\cdot\text{in}$
 $\text{mPa}\cdot\text{s} = \text{cP}$

Note

The data contained herein are furnished for information only and are believed to be reliable. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling and use thereof. In light of the foregoing, **Henkel Corporation specifically disclaims all warranties expressed or implied, including warranties of merchantability or fitness for a particular purpose, arising from sale or use of Henkel Corporation's products. Henkel Corporation specifically disclaims any liability for consequential or incidental damages of any kind, including lost profits.** The discussion herein of various processes or compositions is not to be interpreted as representation that they are free from domination of patents owned by others or as a license under any Henkel Corporation patents that may cover such processes or compositions. We recommend that each prospective user test his proposed application before repetitive use, using this data as a guide. This product may be covered by one or more United States or foreign patents or patent applications.

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Reference 0.3